### AMP | AMP Type III+

TE Internal #: 66102-3

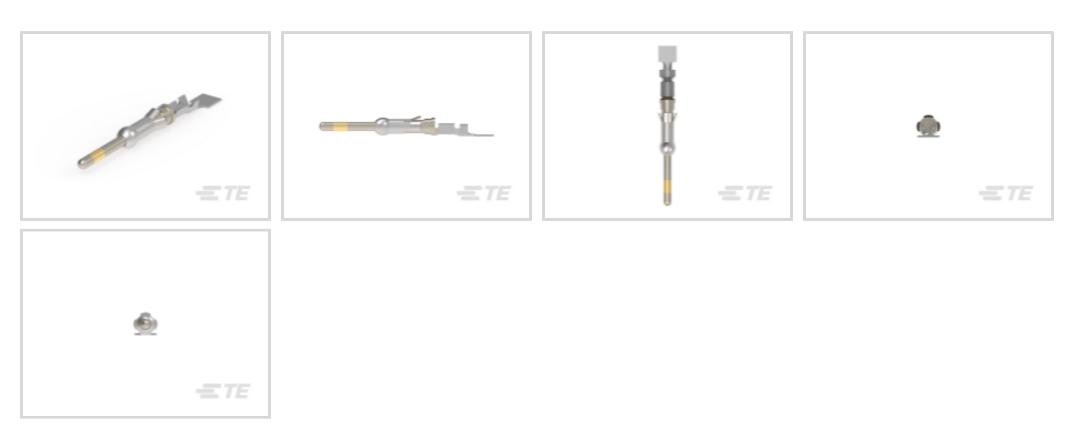
Pin Contact, Gold, Size 16 Contact Size, 24 – 20 AWG Wire Size, .2

– .6 mm² Wire Size, Crimp, Brass, Power & Signal, AMP Type III+

View on TE.com >



#### Connectors > Contacts > Connector Contacts



Contact Type: Pin

Contact Mating Area Plating Material: Gold

Wire Contact Termination Area Plating Material: Tin

Contact Retention Within Housing: With

Contact Size: Size 16

### **Features**

## **Contact Features**

Mating Pin Diameter	1.57 mm[.062 in]
Contact Underplating Material Thickness	1.27 μm[50 μin]
Wire Contact Termination Area Plating Thickness	1.27 µm[50 µin]
Wire Contact Termination Area Plating Material Finish	Matte
Contact Mating Area Plating Material Thickness	.38 μm[15 μin]
Contact Orientation	Straight
Contact Underplating Material	Nickel
Contact Type	Pin
Contact Mating Area Plating Material	Gold
Wire Contact Termination Area Plating Material	Tin
Contact Retention Within Housing	With
Contact Size	Size 16
Contact Base Material	Brass
Contact Current Rating (Max)	13 A

## **Termination Features**



Termination Method to Wire & Cable	Crimp
Product Terminates To	Wire & Cable
Mechanical Attachment	
Wire Insulation Support	With
Dimensions	
Compatible Insulation Diameter Range	1.02 – 2.03 mm[.04 – .08 in]
Wire Size	$.26 \text{ mm}^2$
Usage Conditions	
Operating Temperature Range	-55 – 150 °C[-67 – 302 °F]
Operation/Application  Operation/Application	-55 – 150 °C[-67 – 302 °F]
	-55 – 150 °C[-67 – 302 °F]  Power & Signal
Operation/Application	
Operation/Application  Circuit Application	

### **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous



materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts





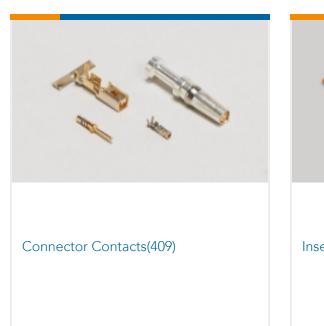


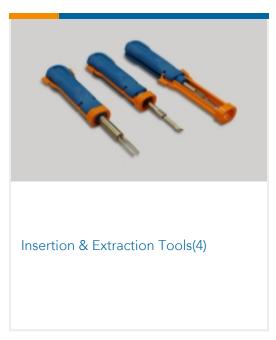






# Also in the Series | AMP Type III+





# Customers Also Bought



















### **Documents**

### **Product Drawings**

III+ PIN,24-20,15AU/FL,STRIP

English

#### **CAD Files**

**Customer View Model** 

ENG\_CVM\_CVM\_66102-3\_BB.2d\_dxf.zip

English

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_66102-3\_BB.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_66102-3\_BB.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

### **Product Specifications**

**Application Specification** 

English

## **Instruction Sheets**

Instruction Sheet (U.S.)

Japanese

Instruction Sheet (U.S.)

English